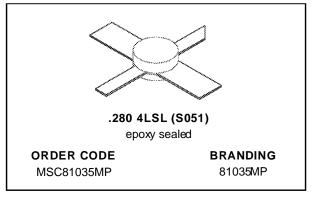


RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- ∞:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- Pout = 35 W MIN. WITH 10.7 dB GAIN

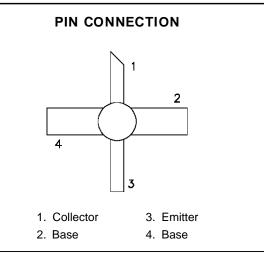


DESCRIPTION

The MSC81035MP is a medium power Class C transistor designed specifically for pulsed L-Band avionics applications. This device is a direct replacement for the MSC1035MP. MSC81035MP offers improved saturated ouput power and collector efficiency based on the test circuit described herein.

Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The MSC81035MP is housed in the IMPAC[™] package with internal input matching.



ABSOLUTE MAXIMUM RATINGS	\mathbf{S} (T _{case} = 25°C	;)
---------------------------------	--	----

Symbol	Parameter	Value	Unit
PDISS	Power Dissipation* $(T_C \le 100^{\circ}C)$	150	W
lc	Device Current*	3.0	А
V _{CC}	Collector-Supply Voltage*	55	V
TJ	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	– 65 to +150	°C

THERMAL DATA

RTH(j-c)Junction-Case Thermal Resistance*1.0°C/W
--

*Applies only to rated RF amplifier operation

Note: Thermal Resistance determined by Infra-Red Scanning of Hot-Spot

Junction Temperature at rated RF operating conditions.

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

STATIC

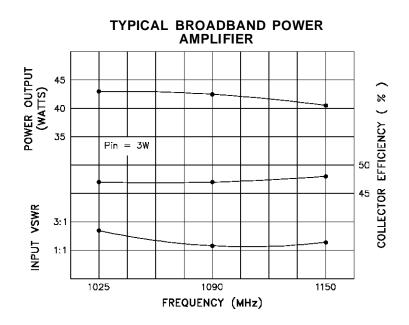
Symbol Test Conditions	Test Conditions	Value			Unit		
	Min.	Тур.	Max.	Unit			
BV _{CBO}	I _C = 10mA	$I_E = 0mA$		65	_		V
BV _{EBO}	I _E = 1mA	$I_C = 0 m A$		3.5	—		V
BVCER	IC = 10mA	$R_{BE} = 10\Omega$		65	_	_	V
ICES	$V_{BE} = 0V$	$V_{CE} = 50V$		_	—	5	mA
h _{FE}	$V_{CE} = 5V$	$I_C = 500 \text{mA}$		15		120	

DYNAMIC

Symbol	Test Conditions	Test Conditions		Value		
Symbol	Symbol Test Conditions		Min.	Тур.	Max.	Unit
Роит	$f = 1025 - 1150 \text{ MHz}$ $P_{IN} = 3.0 \text{W}$	$V_{CC} = 50V$	35	40		W
ης	$f = 1025 - 1150 \text{ MHz} \text{ P}_{IN} = 3.0 \text{W}$	$V_{CC} = 50V$	10.7	11.2	—	%
GP	$f = 1025 - 1150 \text{ MHz}$ $P_{IN} = 3.0 \text{W}$	$V_{CC} = 50V$	43	48	_	dB

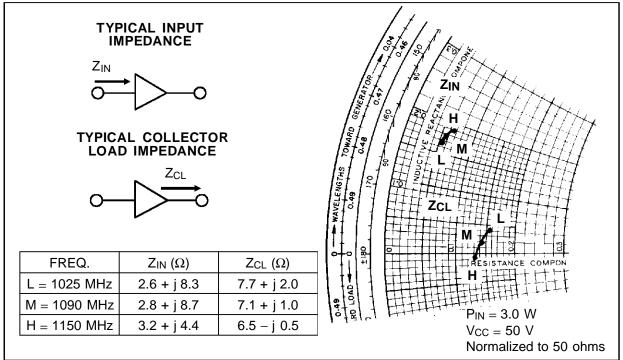
Note: Pulse Width = 10μ Sec Duty Cycle = 1%

TYPICAL PERFORMANCE

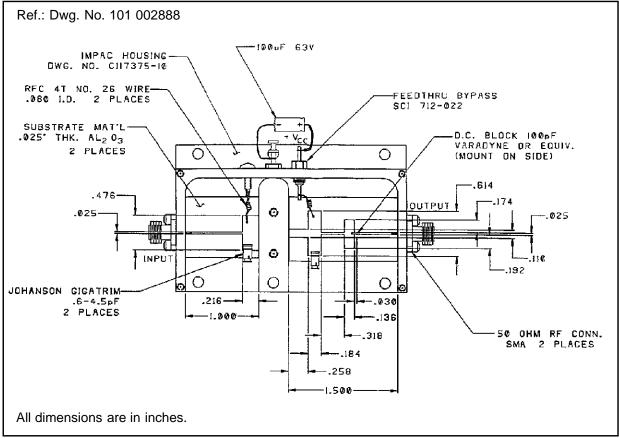




IMPEDANCE DATA

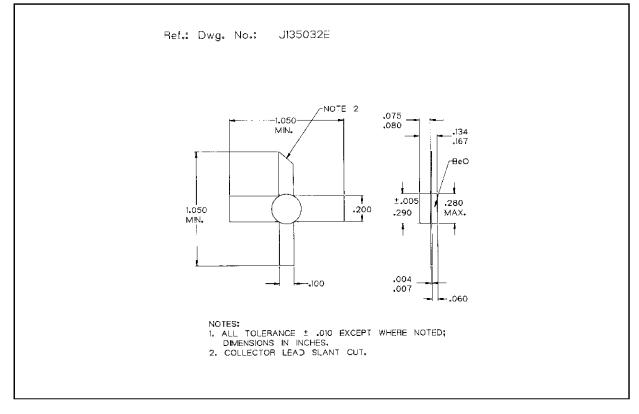


TEST CIRCUIT





PACKAGE MECHANICAL DATA



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectonics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A



This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.